


<b>Application Number</b> 	<b>Application No.</b> 10/081,818	<b>Applicant(s)</b> ELDRIDGE ET AL.	

<b>TERMINAL DISCLAIMER</b> filed 1/18/05 has been:	<input checked="" type="checkbox"/> <b>APPROVED</b>	<input type="checkbox"/> <b>DISAPPROVED</b>
<b>Document Code - DISQ</b>	<b>This patent is subject to a Terminal Disclaimer</b>	
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S/N 10/081,818

PATENT

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant: Jerome M. Eldridge et al.

Examiner: Tu-Tu Ho

Serial No.: 10/081,818

Group Art Unit: 2818

Filed: February 20, 2002

Docket: 1303.045US1

ATOMIC LAYER DEPOSITION OF METAL OXIDE AND/OR LOW  
ASYMMETRICAL TUNNEL BARRIER INTERPOLY INSULATORS



TERMINAL DISCLAIMER

Mail Stop Amendment  
Commissioner for Patents  
P.O. Box 1450  
Alexandria, VA 22313-1450

The PTO did not receive the following  
listed item(s) Check # 130.00,  
But \$ 180.00 for IDS.

I, Timothy B. Clise, am an attorney of record for the above identified patent application as evidenced by the Power of Attorney filed in the present application on February 20, 2002. I am making this petition on behalf of Micron Technology, Inc., the assignee of the present invention. As the attorney of record, I am empowered to act on behalf of the assignee and, in accordance with 37 C.F.R. § 1.321(b)(iv), to sign this terminal disclaimer.

1/24/2005 HNGUYEN1 00000025 190743 10081818

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Certificate Under 37 C.F.R. § 3.73(b)

Your petitioner, Micron Technology, Inc., certifies that it is the owner of the entire right, title and interest in and to the above-identified present patent application (Serial No. 10/081,818) and to U.S. Patent Applications Serial Nos. 09/943,134 and 10/028,001. Your petitioner owns the entire right, title, and interest of by nature of the assignment executed and filed for the present application and U.S. Patent Application Serial Nos. 09/943,134 and 10/028,001. The assignment for the present application, Serial No. 10/081,818, was recorded on February 20, 2002 and is located at Reel 012633, Frame 0093 with the United States Patent and Trademark Office. The assignment for U.S. Patent Application Serial No. 09/943,134 was recorded on August 30, 2001 and is located at Reel 012142, Frame 0662 with the United States Patent and Trademark Office. The assignment for U.S. Patent Application Serial No. 10/028,001 was recorded on December 20, 2001 and is located at Reel 012413, Frame 0348 with the United States Patent and Trademark Office.

The undersigned representative of the assignee has reviewed the evidentiary documents of title and certifies that to the best of assignee's knowledge and belief, title is in the assignee, Micron Technology, Inc., seeking to take the action set forth in this disclaimer.

**TERMINAL DISCLAIMER**

Serial Number: 10/081,818

Filing Date: February 20, 2002

Title: ATOMIC LAYER DEPOSITION OF METAL OXIDE AND/OR LOW ASYMMETRICAL TUNNEL BARRIER INTERPOLY INSULATORS

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Dkt: 1303.045US1**Terminal Disclaimer**

Your petitioner hereby disclaims, except as provided below, the terminal part of the statutory term of any patent granted on the present patent application, which would extend beyond the expiration date of the full statutory term, as presently shortened by any terminal disclaimers, of U.S. Patent Application Serial Nos. 09/943,134 and 10/028,001. Petitioner hereby agrees that any patent so granted on the present application shall be enforceable only for and during such period that the legal title to U.S. Patent Application Serial Nos. 09/943,134 and 10/028,001 and the legal title of the present application and any patent granted thereon remain common, this agreement to run with any patent granted on the present application and to be binding upon the grantee, its successors and assigns.

**Limitations on the Disclaimer**

Your petitioner does not disclaim any terminal part of any patent granted on the present application prior to the expiration date of the full statutory term as presently shortened by any terminal disclaimer of U.S. Patent Application Serial Nos. 09/943,134 and 10/028,001 in the event that they later expire for failure to pay a maintenance fee, are held unenforceable, are found invalid, are statutorily disclaimed in whole or terminally disclaimed under 37 C.F.R. § 1.321(a), have all claims canceled by a reexamination certificate, or are otherwise terminated prior to the expiration date of their statutory term as presently shortened by any terminal disclaimer, except for the separation of legal title as stated hereinabove.

TERMINAL DISCLAIMER

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INSULATORS

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Fee Status

A check in the amount of \$130.00, which is required under 37 C.F.R. § 1.20(d) to file a statutory disclaimer, is enclosed herewith. The Commissioner of Patents and Trademarks is hereby authorized to charge any additional fees or credit overpayment to Deposit Account No. 19-0743.

Respectfully submitted,

JEROME M. ELDRIDGE ET AL

By their Representatives,

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Date

14 Jan '05

By

  
Timothy B. Clise  
Reg. No. 40,957

**CERTIFICATE UNDER 37 CFR 1.8:** The undersigned hereby certifies that this correspondence is being deposited with the United States Postal Service with sufficient postage as first class mail, in an envelope addressed to: Mail Stop Amendment, Commissioner of Patents, P.O. Box 1450, Alexandria, VA 22313-1450, on this 14 day of January, 2005.

Name

KACIA LEE

Signature

Kacia Lee